OK TO ENTER: /DB/

Application. No. 10/582,556

/DB/ 10/03/2009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Tomofumi MAEKAWA Confirmation No.: 9960

Group Art Unit: 1796

Serial No : 10/582,556 (National Stage of PCT/JP2004/018388)

I.A. Filed: December 9, 2004 Examiner: David Buttner

For : THERMOPLASTIC RESIN HAVING RIGIDITY WHEN HEATED

SUPPLEMENTAL RESPONSE UNDER 37 C.F.R. § 1.116

Commissioner of Patents
U.S. Patent and Trademark Office
Customer Window, Mail Stop <u>AMENDMENT</u>
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

This paper responds to the Office Action mailed June 8, 2009, which sets a three-month shortened statutory period for response, to end September 8, 2009, and to the Advisory Action mailed August 31, 2009. Applicants file this paper on or before October 8, 2009 concurrently with a Request for Three-Month Extension of Time and required fee. Applicants authorize the Office to charge any additional fees to Deposit Account No. 19-0089.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 6 of this paper.